

INTERCONNECT STRIPS

BBS, BBL, BHS, BBD & BDL SERIES

Mates with:
SS, SD, HSS, SL, SDL, ESS, ESD

FEATURES

- Low profile design achieves (3,89mm) .153" board spacings when mated with SL series.
- Choice of precision machined (BXX Series) or coined (LBS Series) terminals.
- Approach the reliability of a permanent connection with the flexibility of a separable connection.

SPECIFICATIONS

For complete specifications see www.samtec.com?BBS, www.samtec.com?BBD, www.samtec.com?BBL or www.samtec.com?BDL

BBS, BBD, BBL, BDL



Insulator Material:
Black Glass Filled Polyester (BBS, BBD, BBL)
Black High Temp Nylon (BDL)
Temperature Range:
-55°C to +125°C
Terminal Material:
Phosphor Bronze or Brass
Plating:
Au or Sn over 50µ" (1,27µm) Ni
Current Rating: 1A
RoHS Compliant: Yes
Lead-Free Solderable:
Wave only

SPECIFICATIONS

For complete specifications see www.samtec.com?BHS

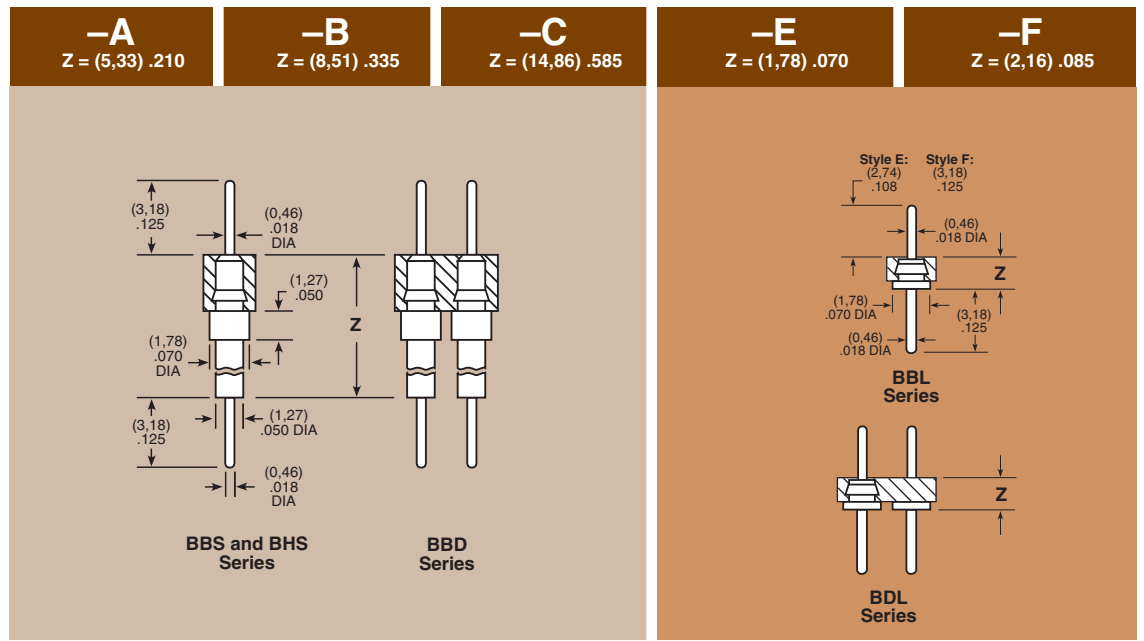
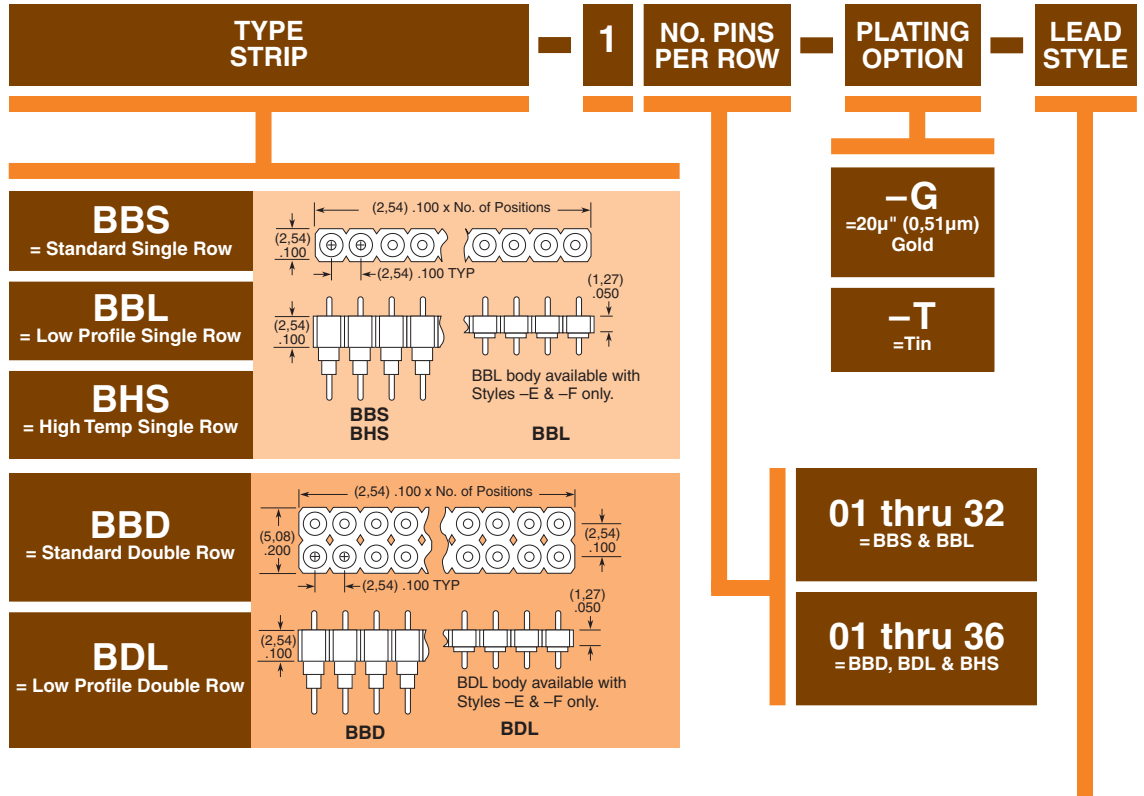
BHS

Same as BBS except:



Insulator Material:
Black Liquid Crystal Polymer
Max Processing Temp:
230°C for 60 seconds, or 260°C for 20 seconds 3x with all Au
RoHS Compliant: Yes
Lead-Free Solderable:
Wave, or reflow with all Au

Note: Some lengths, styles and options are non-standard, non-returnable.



Due to technical progress, all designs, specifications and components are subject to change without notice.

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